HALOGEN FREE

GREEN



www.vishay.com

Vishay Semiconductors

High Speed Infrared Emitting Diode, 940 nm, GaAlAs, MQW

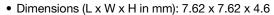


DESCRIPTION

VSLB59530S, is an infrared, 940 nm emitting diode in GaAlAs multi-quantum well (MQW) technology with high radiant power and high speed. It is molded in a clear high power TELUX package with an oval lens resulting in angle of half intensities in vertical direction of \pm 18° and in horizontal direction of \pm 36°.

FEATURES

Package type: leadedPackage form: TELUX



Peak wavelength: λ_p = 940 nm

High reliability

· High radiant power

• High radiant intensity

• Angle of half intensity, vertical: $\varphi_v = \pm 18^\circ$

• Angle of half intensity, horizontal: $\phi_h = \pm 36^{\circ}$

Low forward voltage

· Suitable for high pulse current operation

• High modulation bandwidth: f_c = 24 MHz

· Good spectral matching with Si photodetectors

 Compatible with wave solder processes according to CECC 00802

 Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Emitter source for gesture recognition applications
- Emitter source for 3D TV
- Emitter source for mid range proximity detection
- Emitter source for object/presence detection

PRODUCT SUMMARY					
COMPONENT	I _e (mW/sr)	φ _ν (deg)	φ _h (deg)	λ _p (nm)	t _r (ns)
VSLB9530S	60	± 18	± 36	940	15

Note

· Test conditions see table "Basic Characteristics"

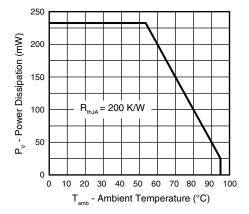
ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
VSLB9530S	Tube	MOQ: 2100 pcs, 70 pcs/tube	TELUX		

Note

• MOQ: minimum order quantity



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	150	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I _{FM}	300	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1.5	Α	
Power dissipation		P_V	232.5	mW	
Junction temperature		Tj	100	°C	
Operating temperature range		T _{amb}	- 40 to + 95	°C	
Storage temperature range		T _{stg}	- 40 to + 100	°C	
Soldering temperature	$t \le 5$ s, 1.5 mm from body preheat temperature 100 °C/30 s	T_{sd}	260	°C	
Thermal resistance junction/ambient		R _{thJA}	200	K/W	



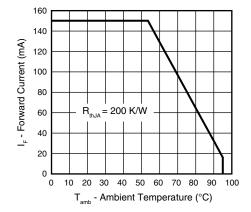


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

Fig. 2 - Forward Current Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V_{F}	1.05	1.28	1.5	V
Forward voltage	$I_F = 150 \text{ mA}, t_p = 20 \text{ ms}$	V_{F}		1.31	1.55	V
	$I_F = 1.5 \text{ A}, t_p = 100 \mu \text{s}$	V_{F}		1.9		V
Temperature coefficient of V _F	I _F = 150 mA	TK _{VF}		- 0.89		mV/K
Reverse current	V _R = 5 V	I _R			10	μA
Junction capacitance	$V_R = 0 \text{ V}, f = 1 \text{ MHz}, E = 0 \text{ mW/cm}^2$	CJ		86		pF
Dedient intensity	$I_F = 150 \text{ mA}, t_p = 20 \text{ ms}$	l _e	40	60	95	mW/sr
Radiant intensity	$I_F = 1.5 \text{ A}, t_p = 100 \mu \text{s}$	l _e		520		mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	φ _e		40		mW
Temperature coefficient of φ _e	I _F = 150 mA	TKφ _e		- 0.42		%/K
Angle of half intensity, vertical		ϕ_{V}		± 18		deg
Angle of half intensity, horizontal		ϕ_{h}		± 36		deg
Peak wavelength	I _F = 30 mA	λ_{p}		940		nm
Spectral bandwidth	I _F = 30 mA	Δλ		25		nm
Temperature coefficient of λ _p	I _F = 30 mA	$TK\lambda_p$		0.25		nm/K
Rise time	I _F = 100 mA, 20 % to 80 %	t _r		15		ns
Fall time	I _F = 100 mA, 20 % to 80 %	t _f		15		ns
Cut-off frequency	I _{DC} = 70 mA, I _{AC} = 30 mA pp	f _c		24		MHz

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

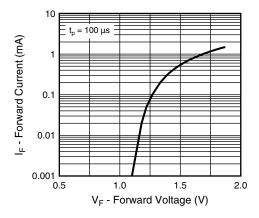


Fig. 3 - Forward Current vs. Forward Voltage

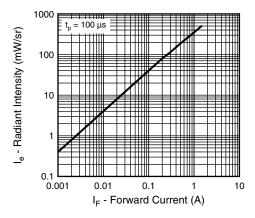


Fig. 4 - Radiant Intensity vs. Forward Current

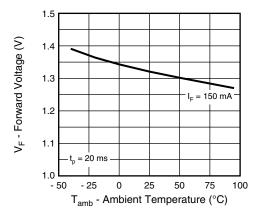


Fig. 5 - Forward Voltage vs. Ambient Temperature

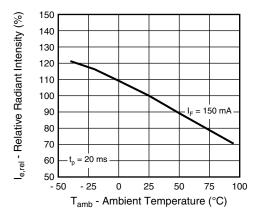


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

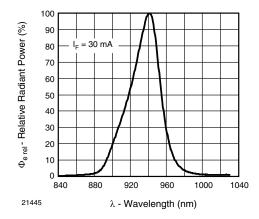


Fig. 7 - Relative Radiant Power vs. Wavelength

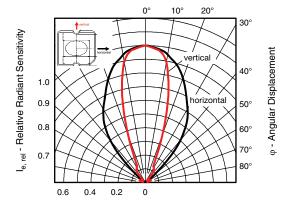
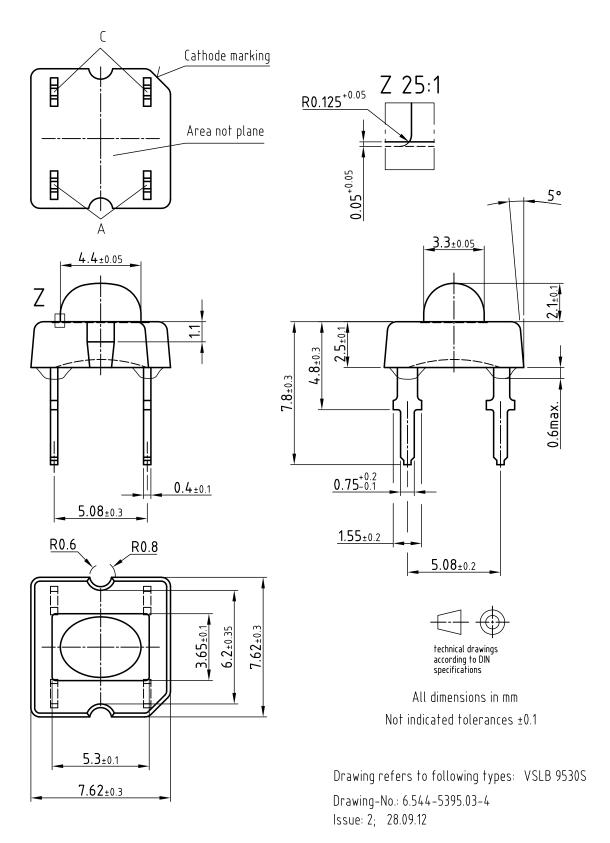


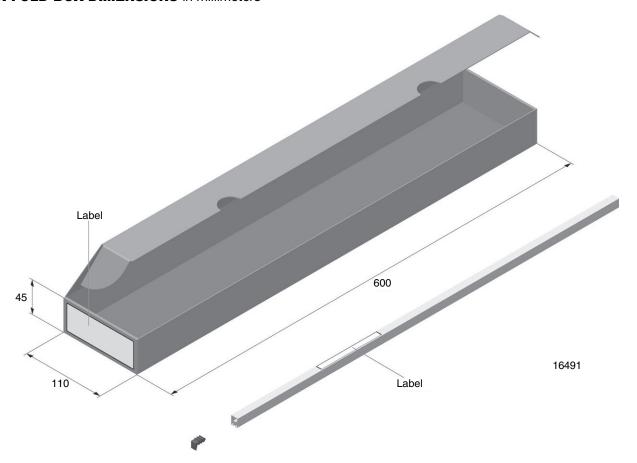
Fig. 8 - Relative Radiant Intensity vs. Angular Displacement



PACKAGE DIMENSIONS in millimeters



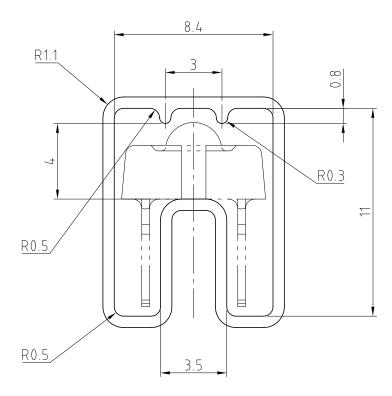
FAN FOLD BOX DIMENSIONS in millimeters





TUBE WITH BAR CODE LABEL DIMENSIONS in millimeters

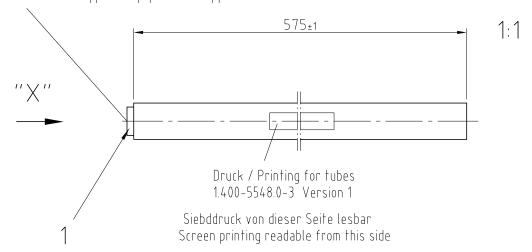




Wanddicke/wall thickness: 0.6±0.1 Geradheit/Straightness 2 Schnittwinkel/cut 90° ±1°

Geprüft nach/approved to: LV 5145

Bestücken mit 1 Stopper / equip with 1 stopper



Drawing-No.: 9.700-5223.0-4 Rev. 2; Date: 23.08.99

20438



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com